

Product Compliance Declaration

Please see <u>www.molex.com</u> for the most up-to-date information.

Contact Information					
Name	Molex Product Compliance	E-Mail	Product.Compliance@molex.com		
Part Informa	ation				
Part Number	1054051108	Part Weight	1.1778G		
Part Name	Nano Fit SMT R/A Hdr 2X4 Blk tin				

Product Composition

Name	Type CAS Number		Proportion (% Total)	Mass (Grams)	
Nano Fit SMT R/A Hdr 2X4 Blk tin	Assembly		100	1.1778	
Nano Fit SMT R/A Hdr HSG 2X4 Blk	Component		46.6972	0.55	
LCP-GF30	Material		46.6972	0.55	
Carbon black	Substance	1333-86-4	0.2335	0.00275	
LCP	Substance		31.7541	0.374	
Further Additives, not to declare	Substance	system	0.7005	0.00825	
GF-Fibre	Substance		14.0092	0.165	
Nano Fit SMT R/A Hdr L TML tin	Assembly		23.7731	0.28	
Nano Fit SMT R/A Hdr L TML w/o plated	Component		20.377	0.24	
Yellow Brass 66% Unplated	Material		20.377	0.24	
Copper	Substance	7440-50-8	13.4997	0.159	
Zinc (metal)	Substance	7440-66-6	6.8772	0.081	
NICKEL CROWN ANODE	Material		2.1396	0.0252	

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Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)	
Nickel	Substance	7440-02-0	2.1396	0.0252	
TIN BALL ANODE	Material		1.2566	0.0148	
Tin	Substance	7440-31-5	1.2566	0.0148	
Nano Fit SMT R/A Hdr S TML tin	Assembly		18.0676	0.2128	
Nano Fit SMT R/A Hdr S TML w/o plated	Component		16.9808	0.2	
Yellow Brass 66% Unplated	Material		16.9808	0.2	
Copper	Substance	7440-50-8	11.2498	0.1325	
Zinc (metal)	Substance	7440-66-6	440-66-6 5.731		
NICKEL CROWN ANODE	Material		0.6113	0.0072	
Nickel	Substance	7440-02-0	0.6113	0.0072	
TIN BALL ANODE	Material		0.4755	0.0056	
Tin	Substance	7440-31-5	0.4755	0.0056	
Nano Fit SMT R/A Hdr Clip-S tin	Assembly	nbly 1		0.135	
Nano Fit SMT R/A Hdr Clip-S w/o plated	Component		10.1885	0.12	
Yellow Brass 66% Unplated	Material		10.1885	0.12	
Copper	Substance	7440-50-8	6.7499	0.0795	
Zinc (metal)	Substance	7440-66-6	3.4386	0.0405	
NICKEL CROWN ANODE	Material		0.3906	0.0046	
Nickel	Substance	7440-02-0	0.3906	0.0046	
TIN BALL ANODE	Material		0.883	0.0104	
Tin	Substance	7440-31-5	0.883	0.0104	

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ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

REACH-SVHC Declaration Information

Regulatory Revision D(2020)4578-DC (25 June 2020)

Contained Substances Exceeding Threshold

None

GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added	
lead	e-plate Sn (electrodeposited Tin Coatings, bright and matt)	*Note	500	Yes	
lead	C2680	*Note	250	Yes	
nickel powder [particle diameter < 1 mm]	NICKEL CROWN ANODE	*Note	1,000,000	Yes	
nickel powder [particle diameter < 1 mm]	Ep-Ni	*Note	997,500	Yes	
copper	C2680	*Note	660,000	Yes	
glass, oxide, chemicals	LCP-GF30	*Note	300,000	Yes	

*Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

Part Name

Exemption

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Exemptions

Part Name	Exemption		
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits		
C2680	44 Concentration within acceptable GADSL limits		
NICKEL CROWN ANODE	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/ cm2/week)		
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/ cm2/week)		

HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

None

China ROHS Declaration Information

Part Number 1054051108 Part Name Nano Fit SMT R/A Hdr 2X4 Blk tin						
Part Information		На	zardous \$	Substance	es	
Components	Lea	d Mercury	Cadmium	Hex. Chromium	PBB	PBDE
Nano Fit SMT R/A Hdr 2X4 Blk tin	0	0	0	0	0	0
Nano Fit SMT R/A Hdr HSG 2X4 Blk	0	0	0	0	0	0
Nano Fit SMT R/A Hdr L TML tin		0	0	0	0	0
Nano Fit SMT R/A Hdr L TML w/o plated		0	0	0	0	0
Nano Fit SMT R/A Hdr S TML tin	0	0	0	0	0	0
Nano Fit SMT R/A Hdr S TML w/o plated	0	0	0	0	0	0
Nano Fit SMT R/A Hdr Clip-S tin		0	0	0	0	0
Nano Fit SMT R/A Hdr Clip-S w/o plated		0	0	0	0	0

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Process Information

Component Plating / Surface Finish	N/A
Termination Base Alloy	N/A
Solder Alloy	N/A
Process Capability	N/A
Maximum Exposure Time (seconds)	N/A
Maximum Process Temperature (C)	N/A
Maximum Cycles at Reflow Temperature	N/A
J-STD-020 Moisture Sensitivity Level	N/A

Dec 8, 2020

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